## Information Disclosure Statement USSN 10/787,276 May 4, 2004

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HAT STRADE	Porm PTO-1449 (Modified)	ATTY DOCKET NO. U.S. SERIAL NO.   B-4712 620052-7 10/787,276			
	LIST OF PATENTS AND PUBLICATIONS	APPLICANTS Peter D. BREWER			
	STATEMENT	FILING DATE February 25, 2004	GROUP 2813 not yet assigned		

## U.S. PATENT DOCUMENTS

EXAMINER INITIAL	document Number	ISSUE DATE	NAME	CLASS	SUB- Class	FILING DATE of 102(e) date if Appropriate

## FOREIGN PATENT DOCUMENTS

DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO
				$\overline{\ }$	

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

	Parker,	E.H.C.	, The	Techn	ology	and	Physics	of Molecular	Beam Epitaxy,
'	Plenum	Press,	New Y	ork, p	p. 90	-93,	138-139	(1985).	

Tong, Q.-Y., et al., Semiconductor Wafer Bonding, Science and Technology, The Electrochemical Society Series, pp. 33-51 (1999).

EXAMINER	PATE CONSIDERED
	12/29/05

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPRP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.